# OMRON MOS FET Relay

G3VM-W

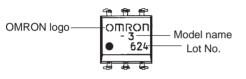
## G3VM Low-cost Series (Two-output Models)

- New G3VM Series with 350-V-output dielectric strength.
- Two-output models now available.
- Approved Standards: UL1577



## **Ordering Information**

#### Appearance



Note: "G3VM" is not printed on the actual product

#### Model Number Legend



- 1 2
- 1. Load Voltage
  - W: Load voltage, 350 VDC or 350 VAC min.

#### 2. Terminal

F: Surface-mounting terminals None: PCB terminals

Contact form	Terminals	Load voltage (peak value)	Model	Number per stick
DPST-NO	PCB terminals	350 VAC	G3VM-W-S	50
	Surface-mounting terminals	1	G3VM-WF-S	50

## Specifications —

#### ■ Absolute Maximum Ratings (Ta = 25°C)

		Item	Symbol	Rating	Unit
Input	LED forward curre	ent	I <sub>F</sub>	50	mA
	LED forward curre	ent reduction rate (Ta≧25°C)	$\Delta I_{F}^{\circ}C$	-0.5	mA/°C
	LED forward current reduction rate (Ta $\geq$ 25°C)Repetitive peak LED forward current (100 µs pulse)LED reverse voltageConnection temperatureOutput dielectric strengthContinuous load currentON current reduction rate (Ta $\geq$ 25°C)Current per channel	ED forward current (100 $\mu$ s pulse)	I <sub>FP</sub>	1	А
			V <sub>R</sub>	5	V
	Connection tempe	erature	Tj	125	°C
Output	Output dielectric s	strength	V <sub>OFF</sub>	350	V
		Current per channel	Ι <sub>Ο</sub>	120	mA
	reduction rate	Current per channel	$\Delta I_{ON}/^{\circ}C$	-1.2	mA/°C
	Connection tempe	erature	Т <sub>і</sub>	125	°C
Storage	temperature		T <sub>stg</sub>	-55 to 100	°C
Operati	ng temperature		Ta	-20 to 85	°C
Solderin	ng temperature (10 s	5)	T <sub>sol</sub>	260	°C
Dielectr less) (se		1 min with ambient humidity of 60% or	V <sub>I-O</sub>	2,500	V <sub>rms</sub>

**Note:** Apply voltage between a group of pins 1, 2, and 3, 4 and that of pins 8, 7 and 6, 5.

#### Recommended Operating Conditions

Item	Symbol	Minimum	Typical	Maximum	Unit
Operating voltage	V <sub>DD</sub>			280	V
Forward current	I <sub>F</sub>	5.0	7.5	25	mA
Continuous load current	I <sub>O</sub>			100	mA
Operating temperature	Та	-20		65	°C

#### ■ Electrical Characteristics (Ta = 25°C)

	ltem	Symbol	Measurement conditions	Minimum	Typical	Maximum	Unit
Input	LED forward current	V <sub>F</sub>	I <sub>F</sub> =10 mA	1.0	1.15	1.3	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> =5 V			10	μΑ
	Capacity between terminals	CT	V=0, , f=1MHZ		30		pF
Output	Current leakage when the relay is open	I <sub>LEAK</sub>	V <sub>OFF</sub> =350 V			1	μΑ

#### ■ Connection Characteristics (Ta = 25°C)

Item	Symbol	Measurement conditions	Minimum	Typical	Maximum	Unit
Maximum resistance with	R <sub>ON</sub>	I <sub>ON</sub> =100 mA, I <sub>F</sub> =10 mA		22	35	Ω
output ON		I <sub>ON</sub> =20 to 100 mA, I <sub>F</sub> =10 mA		26	40	

#### ■ Insulation Characteristics (Ta = 25°C)

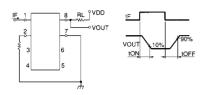
Item	Symbol	Measurement conditions	Minimum	Typical	Maximum	Unit
Floating capacity between I/O terminals	C <sub>I-O</sub>	V <sub>S</sub> =0, f=1MH <sub>Z</sub>		0.8		pF
Insulation resistance	R <sub>I-O</sub>	$V_S=0$ , operating ambient humidity: $\leq 60\%$	5 x 10 <sup>10</sup>	1014		Ω
Dielectric strength	V <sub>I-O</sub>	AC for 1 min	2,500			V <sub>rms</sub>
		AC for 1 s in oil		5,000		
		DC for 1 min in oil		5,000		V <sub>dc</sub>

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#### ■ Switching Characteristics (Ta = 25°C)

Item	Symbol	Measurement conditions	Minimum	Typical	Maximum	Unit
Turn-on time	t <sub>ON</sub>	R <sub>L</sub> =200 Ω V <sub>DD</sub> =20 V,			1	ms
Turn-off time	t <sub>OFF</sub>	I <sub>F</sub> =10 mA (see note)			1	

Note: Switching Time Measuring Circuit



### **Engineering Data**

0.6

0.8

1.0

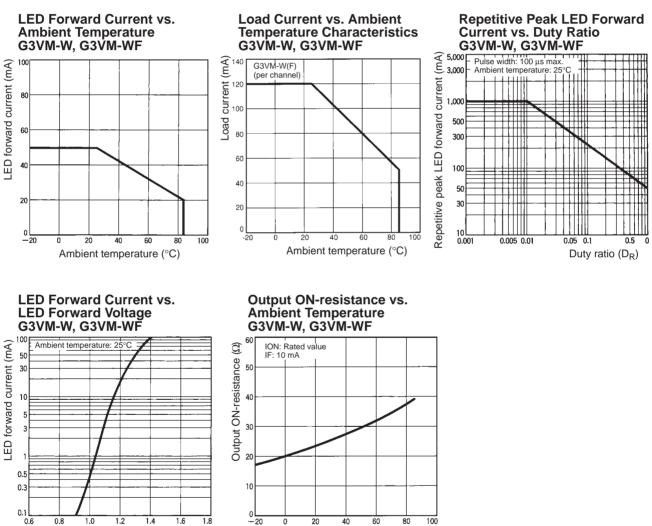
1.2

LED forward voltage (V)

1.4

1.8

1.6



20

40

Ambient temperature (°C)

60

100

80

Eight, 0.8-dia. hole

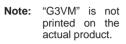
(0.56)

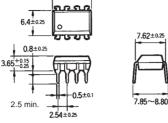
(0.56) -(0.1)

### Dimensions

Note: All units are in millimeters unless otherwise indicated. G3VM-W







9.66±0.25

#### G3VM-WF



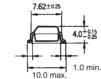
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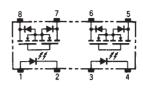
1.2±0.15

 $3.65^{+0.19}$ 

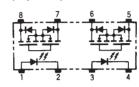
2.54±0.25



Terminal Arrangement/ Internal Connections (Top View)



Terminal Arrangement/ Internal Connections (Top View)



Actual Mounting Pad Dimensions (Recommended Value, Bottom

PCB Dimensions

-2.54

(Bottom View)

(0.1)

